

## PATENT APPLICATION

Sheet 1 of 4

FORM PTO-1449

LIST OF PATENTS AND PUBLICATIONS FOR  
APPLICANT'S INFORMATION DISCLOSURE  
STATEMENT

(Use several sheets if necessary)

ATTY. DOCKET NO.

200312380-1

APPLICATION NO.

CONFIRMATION NO.

APPLICANT

Greibenkemper, John

FILING DATE

April 9, 2004

GROUP

## REFERENCE DESIGNATION

## U.S. PATENT DOCUMENTS

| EXAMINER<br>INITIAL |    | DOCUMENT<br>NUMBER | PUBLICATION<br>DATE | NAME         | Pages, Columns, Lines Where<br>Relevant Passages or Figures Appear |
|---------------------|----|--------------------|---------------------|--------------|--|
| HL                  | 1A | 5,065,284          | 11-12-1991          | Hernandez    |  |
| HL                  | 1B | 5,246,817          | 09-21-1993          | Shipley, Jr. |  |
| HL                  | 1C | 6,444,922 B1       | 09-03-2003          | Kwong        |  |
|                     | 1D |                    |                     |              |  |
|                     | 1E |                    |                     |              |  |
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|  | 1O |                    |                     |                                  |   |                                     |
|  | 1P |                    |                     |                                  |   |                                     |

## OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.)

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| HL | 1R | PCBs, EE6471 (KR), November 12, 2002, pp. 259-286.  |  |  |  |  |
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**PATENT APPLICATION**

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| <p>APPLICANT<br/><b>Grebenkember, John</b></p>   |  |                        |                         |
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|  | 4P                 |                     |                                  |   |                                     |

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